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Improved Technology Readiness Assessment Framework for System-of-Systems From a System Integration Perspective

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ABSTRACT The military of the Republic of Korea utilizes technology readiness assessment (TRA) to quantitatively evaluate the maturity of domestic technologies. TRA is a key tool for determining the research and development potential in the country. As TRA employs hardware (HW)-oriented technology readiness levels (TRLs), it is suitable for independently assessing individual technologies. However, it has limitations in terms of evaluation from a system-integration perspective. Additionally, the results of checklist-based assessments are highly likely to involve subjectivity, which may yield sparse quantitative insights. This study proposes an enhanced TRA framework in which TRA procedures and criteria are redefined from the system-integration perspective. A framework that can overcome the limitations of the current TRL and TRA frameworks and enable easier, more intuitive assessments is developed. The proposed framework distinguishes between a technology element and a critical technology element (CTE) in terms of HW, software (SW), and interface (IF) and redefines TRLs. Under this framework, TRA is performed according to the TRLs that are redefined in terms of HW, SW, and IF; considering risk management, the lowest evaluation value is used as the system maturity level. The proposed CTE selection method minimizes external evaluator interventions by considering the quantitative goals of the key required operational capabilities, development difficulties, and applications of commercial off-the-shelf technologies. The effectiveness of this framework is confirmed through a case study involving three systems of systems. The results of this study can inspire research at the framework level and contribute to the improvement of existing TRA systems.

INDEX TERMS Integration readiness level, system readiness level, technology readiness assessment, technology readiness level.

I. INTRODUCTION

Weapon systems are becoming increasingly intelligent, unmanned, and integrated into the system of systems (SoS). The weapon system acquisition policy of the South Korean military prioritizes domestic research and development (R&D) as well as the procurement of commercial products. Technology readiness assessment (TRA) is a crucial tool for quantitatively evaluating current domestic technological levels, judging the feasibility of domestic R&D, and managing the associated risks. Since its introduction

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to the South Korean military in the early 2000s, the TRA system has undergone continuous improvements to better align with the current domestic environment for weapon system R&D projects. However, the current TRA still relies on a hardware (HW)-oriented technology readiness level (TRL), which is suitable for assessing individual technologies but has limitations in evaluating the system readiness level (SRL). Moreover, checklist-based evaluations with ambiguous phrases frequently involve subjective judgments. Efforts have been made to address these limitations through research on the integration readiness level (IRL) and SRL; however, the results have not been formally institutionalized.



This study proposes an improved TRA framework that overcomes the limitations of the current TRL and TRA by redefining the TRA procedures and criteria from the system-integration perspective of systems engineering (SE). In this study, a technology element (TE) refers to a specific and discrete component of a technology that can be assessed and measured for its maturity level. It represents a fundamental building block or aspect of a technological system. A critical technology element (CTE) refers to a specific technology component or aspect that is deemed critical for the successful development or operation of a system. CTEs have a substantial impact on the overall performance, schedule, cost, and risk of the system. The selection method for CTEs provides specific approaches for deriving and selecting TEs and CTEs from a system-integration perspective, starting with the development of a technical work breakdown structure (WBS). In particular, the proposed method utilizes certain quantifiable targets of the key required operational capabilities (ROCs), technological development difficulty levels, and application of commercial off-the-shelf (COTS) technologies to minimize the frequency of subjective judgments. For technology evaluation, TRA utilizes the TRL, which has been redefined in terms of HW, software (SW), and interfaces (IFs) from a system-integration perspective. We conducted case studies on the proposed framework and confirmed its practicality and substantial practical value. The major contributions of this study are summarized as follows:

- A TRA method focusing on the system-integration perspective based on SE is presented.
- External evaluator interventions are minimized using methodology-level TRA procedures.
- An intuitive and easy TRA method with consistent results is provided.
- Practical CTE selection procedures are provided.
- Experts familiar with system engineering can easily learn the TRA method.

In Section II, key issues related to the topic are identified by analyzing the TRA system and related studies. Section III presents the proposed TRA framework addressing these challenges. Section IV presents a case study conducted for verifying the effectiveness of the framework. Finally, Section V concludes the paper.

II. RELATED REGULATIONS

A. REGULATIONS AND POLICIES RELATED TO TRA

According to the Orders for the Development of War Capabilities, the military of the Republic of Korea (ROK) prioritizes domestic development and COTS item purchases for acquiring weapon systems [1]. Since 2021, the Defense Acquisition Program Administration (DAPA) has been promoting priority acquisition policies for Korean products to support the domestic defense industry and elevate defense science and technology capabilities [2]. Following the establishment of the DAPA in 2006, it ratified institutional foundations for the TRA of the ROK military in the erstwhile Defense Acquiring

sition Program (ACT). Until 2011, this TRA program was utilized in various projects; however, the absence of specific guidelines in this assessment has limited its use as a basis for determining whether to proceed with the projects. Nevertheless, in 2011, the DAPA actively promoted the use of TRA to prevent project failures owing to insufficient technological maturity, establishing it as a key decision-making tool for domestic R&D projects [3]. Consequently, TRA was conducted according to the Technical Maturity Evaluation Work Guidelines (2019) set by the DAPA.

This version of TRA was applied to precedent studies, exploratory developments, integrated exploratory and system developments, advanced concept technology demonstrations, and critical technology research and test development projects.

The assessment was performed in the following sequence: 1) preliminary work, 2) CTE selection, and 3) assessment [4]. The National Aeronautics and Space Administration (NASA) [5], Department of Defense (DoD) [6], and Government Accountability Office (GAO) have provided valuable guidelines for performing TRA [7]. All of these guides emphasized the importance of clear CTE selection and objective TRA evaluations involving independent expert teams. The DoD initiated the streamlining of acquisition program procedures in 2011; consequently, TRA was conducted only for major defense acquisition programs (MDAPs) and projects with technological risks. The DoD TRA guide has reduced the mandatory requirement to achieve TRLs at all major milestones and now limits TRA execution only to Milestone B of a MDAP. While NASA and DoD did not use a specific definition for SW TRLs, the GAO recognized the difference between HW and SW TRLs and included a definition for SW TRLs in its guide.

B. LITERATURE ON TRA

The TRL metric was initially developed by Sadin et al. [8] of NASA in 1974 using a seven-level scale. The current TRL framework was established in 1990 using a nine-level scale and was formalized by Mankins in 1995 [9]. Subsequently, the TRL metric of NASA has been adopted extensively by various US government agencies, such as the DoD, Department of Energy, and Department of Transportation, as well as by European space agencies.

However, concerns have been raised regarding the limitations of relying solely on this nine-level TRL metric for TRA. For example, Cornford and Sarsfield [10] highlighted the demerits and challenges of assessing technological maturity using the TRL metric established by NASA: 1) it provides subjective assessments; 2) it is not focused on system-to-system integration; 3) it is focused on HW and not SW; 4) it is not well integrated into cost and risk modeling; and 5) it is lacking in definitions for terminologies.

Research on technology integration began with the proposal of the integrated technology analysis methodology and integrated technology index (ITI) as indicators of technology



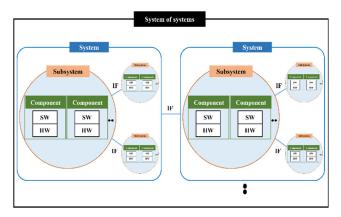


FIGURE 1. Structure of a system of systems (SOS). SW: software; HW: hardware; IF: interface.

integration by Mankins [11]. However, the ITI has limitations from the system-integration perspective. In response, the UK Ministry of Defense developed technology insertion metrics and applied integration maturity levels to assess integration maturity.

Gove [12] developed the IRL to assess the IF maturity among CTEs to overcome the demerits of the TRL, which measures the maturity of a piece of technology. This metric not only measured the IF maturity between CTEs, but also provided directions for improving the integration perspective with other technologies. Subsequently, this metric was expanded from a seven-level scale to a nine-level scale. Sauser et al. [13] proposed a five-level SRL, which is a system-level technological maturity metric derived from a matrix using TRL and IRL metrics.

Mankins [11] introduced the R&D degree of difficulty (R&D3) as the difficulty level in maturing individual technologies, whereas Bilbro [14] proposed the advanced degree of difficulty (AD2), which is similar to R&D3. Olechowski et al. [15] analyzed the application of TRL in various industries worldwide and identified 15 improvement challenges in terms of system complexity, planning and review, and assessment feasibility. Tomaschek et al. [16] surveyed TRL practitioners from diverse industries globally and identified four high-priority improvement challenges: system complexity, technology integration representation, IF maturity, and system-level maturity.

Tompkins et al. [17] proposed an approach that employed a design structure matrix (DSM) to assess the SRL of complex systems. Additionally, they presented a framework for incorporating the current SRL calculation method into the DSM tool. Doukas [18] discussed the applications and opportunities for high-temperature superconducting transmission system links, summarized the major technical challenges to be overcome by the academic community, and used TRLs to assess the technical readiness of alternating current and direct current options.

Petrovic and Hossain [19] developed a fuel-cell technology readiness level (FCTRL) assessment tool for application to

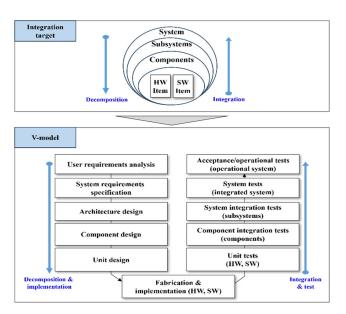


FIGURE 2. Major activities in systems engineering (SE).

fuel-cell technologies. This method comprised seven levels of maturity, with three sublevels (i.e., questions) at each level. The FCTRL methodology was developed for experts, engineers, and professionals who need to evaluate fuel-cell technologies for integration into existing systems and applications, as well as for those with a general interest in fuel cells and renewable energy systems [19].

Jesus and Chagas Jr. [20] developed a methodology for applying IRLs using architectural views through a design structure and domain-mapping matrices. They also provided suggestions for holistic systems analysis and managerial communication applications using this method, and recommended a rationale for assessing the IRLs of legacy systems [20].

C. ENGINEERING ACTIVITIES OF MAJOR SYSTEMS: SYSTEM-INTEGRATION PERSPECTIVE

The weapons system of the ROK military has been developed based on SE. An SoS can be decomposed into the elements system, subsystem, components, and HW/SW, as illustrated in Fig. 1.

Integration within a complex system is realized through IF connections between these levels following a top-down approach. The integration targets and engineering activities in the R&D of the SE-based weapons system are illustrated in Fig. 2.

The left-hand side of the V-model represents a top-down perspective, where the requirements are analyzed, designed, and implemented. Requirements focusing on the key ROCs are established based on operational concepts. The well-defined requirements from the analysis phase are allocated to the HW/SW component design during the design phase. Developers implement HW and SW according to the requirements reflected in the design during the imple-



mentation phase. From a system-integration perspective, system-level requirements drive the identification and incorporation of internal and external interfaces into designs. The interfaces are developed according to the design during the implementation phase. The target of system integration is HW/SW components. The interfaces can be categorized as follows: HW-HW, HW-SW, and SW-SW.

The right-hand side of the V-model represents the bottomup perspective, where the verification activities (system integration test, development, and operational test) progress through a unit test of the HW/SW components, followed by stepwise integration and verification (in the reverse order) up to the subsystem and system levels. The unit test ensures that the developed HW/SW components manufactured and implemented as designed, and the integration perspective focuses on the verification and validation of IFs through stepwise integration and verification processes to confirm the fulfillment of the requirements. From the system-integration perspective, the targets of integration are the HW and SW components, while the IFs serve as a means of integrating them. Therefore, in the context of TRA, the TE, CTE, and TRA need to be distinguished from the perspectives of HW, SW, and IF, and each should be evaluated accordingly.

D. IDENTIFICATION OF KEY ISSUES

The TRA adopted by the ROK military was institutionalized in 2006 and is currently a key decision-making tool in determining the domestic R&D of weapons systems [3]. However, several contentious issues remain unresolved. In this study, we identified two key issues in the CTE selection and TRLs/TRA.

First, the following issues may arise in the selection of a CTE. If a specific CTE is excessively prioritized, the concentration of resources required for important technologies will become dispersed. However, if the CTE is under-identified or overlooked, it may fail to meet the requirements, thereby hindering the success of the project [7]. The CTE selection method used in Korea consists of a checklist method that includes abstract terms, which introduces subjectivity and facilitates potential interventions. Therefore, the validity of CTEs is frequently debated in CTE selection meetings. To resolve this issue, the criteria for CTE selection should be clarified and the selection process should be broken down at the methodological level to minimize the subjective interpretations prevalent under the current checklist approach.

The proposed CTE selection method minimizes external evaluator interventions by considering the quantitative goals of the key required operational capabilities, development difficulties, and applications of COTS technologies.

At present, TEs and CTEs are not identified separately in terms of HW, SW, and IF technologies. To perform TRA from a system-integration perspective, the TEs and CTEs need to be distinguished from the perspectives of these technologies.

Second, from the perspective of the TRL/TRA, the ninelevel TRL, which is used in almost all jurisdictions domestically and internationally, is only specialized for individual

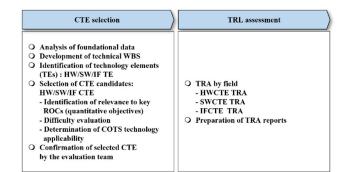


FIGURE 3. Proposed high-level technology readiness assessment (TRA) framework. CTE: critical technology element; TRL: technology readiness level; WBS: work breakdown structure; TE: technical element; ROC: required operational capability; COTS: commercial off-the-shelf; HWCTE: hardware CTE; SWCTE: software CTE; IFCTE: interface CTE.

technologies. As mentioned previously, it has several limitations [10]. Research on IRL and SRL has been conducted to address these limitations; however, the results have not been institutionalized yet. The IRL identifies the IF technologies between individual CTEs and evaluates the maturity of the IF technologies. From the SE system-integration perspective, this aspect must be reinforced and detailed procedures must be presented for defining the integration target, identifying the IF, and deriving the technology that is required for the IF.

An SRL quantifies the overall technological maturity of a system using a matrix that includes both the TRL and IRL. As the SRL is also based on HW-oriented TRL, it does not differentiate among HW, SW, and IF technologies. From the perspective of system integration, HW, SW, and IF TRLs must be segregated to perform their respective TRAs. The SRL is more useful and meaningful for comparing overall maturity between systems. However, because TRA is primarily focused on risk management using immature technologies, utilizing the lowest technological maturity among HW, SW, and IF CTEs for system-level maturity is more reasonable.

As mentioned previously, the contemporary TRA adopts a checklist approach that is prone to evaluator subjectivity and does not evaluate HW and SW separately. Clarification and refinement of the checklist items will be helpful steps. However, if each level can be delineated by distinguishing the output level and verification environment of each indicator, an intuitive evaluation can be performed using only the TRL indicators.

III. TRA FRAMEWORK FROM A SYSTEM-INTEGRATION PERSPECTIVE

A. OVERVIEW OF THE TRA FRAMEWORK

The proposed TRA framework is illustrated in Fig. 3. It consists of two stages: CTE selection and TRL evaluation (existing preliminary preparation activities have been excluded from the research scope).

In the CTE selection stage, candidate CTEs were identified from the results of basic data analysis, and an evaluation team



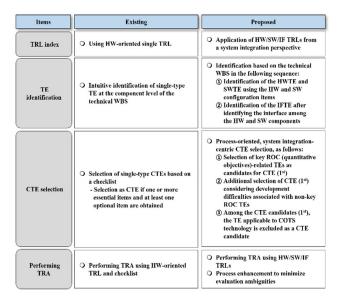


FIGURE 4. Differences between proposed and existing frameworks.

comprising experts finalized the CTEs during meetings. The CTE selection process at a higher level is not significantly different from that at the regular level.

However, significant differences exist among the lower-level activities. The selection of CTEs was based on the results of TE identification, which involved identifying key technologies related to the ROC (quantitative targets), assessing technology difficulties, and considering applications of COTS technologies. Furthermore, from the perspective of system integration, the TE and CTE were identified separately in terms of HW, SW, and IF technologies. The TRA for the CTE was performed in each domain using the redefined TRLs from the perspectives of HW, SW, and IF.

Subsequently, a TRA report that documented the evaluation results for the HW, SW, and IF CTEs was prepared. System-level maturity was defined as the lowest technological maturity level from a risk-management perspective. Maturity plans for immature technologies were developed for CTEs that did not meet the criteria for key milestones in the current acquisition phase.

The differences between the proposed and existing approaches are depicted in Fig. 4.

B. SELECTION OF CTEs

The detailed process of CTE selection is illustrated in Fig. 5. First, a technical WBS was developed based on an analysis of foundational data. Then, the technical WBS was structured into system–subsystem–component–HW/SW items. The HWTE and SWTE required for each structured HW/SW configuration item were identified and the HWTE and SWTE were defined. Then, the IF between the HW/SW configuration items of the components was identified through an operational concept analysis. Thereafter, the definition for the IFTE, which is the technology required to implement the identified IF, was written. Based on the analysis of quantita-

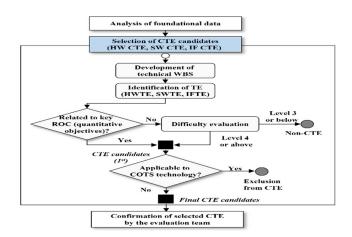


FIGURE 5. Procedure for CTE selection.

Difficulty	Definition of difficulty level
0	Existing technologies
2	Existing technology that needs partial modifications
3	New technology that can be developed sufficiently by utilizing existing technologies
4	New technology that only slightly resembles existing technologies, raising the need for new developments
6	Entirely new technology that does not resemble existing technologies

FIGURE 6. Different difficulty levels in technology development.

tive metrics related to the key quantitative objective criteria (ROCs), CTE candidates (first round) were selected for the identified HW/SW/IF TE.

The key ROC quantitative metrics were performance criteria that need to be satisfied; they impact the scheduling and cost most significantly. The approach to determining the relevance between key ROC quantitative metrics and TEs was similar to that of allocating requirements to the HW/SW components in SE-based R&D. Technical difficulty assessment (TDA) was conducted for TEs that did not correspond to key ROCs, and TEs with difficulty levels of four or higher were added to the pool of CTE candidates (first round). Metrics were used for different levels of the TDA, which are shown in Fig. 6.

The TDA metrics were redefined versions of the AD2 metrics proposed by Bilbro [14]. The higher the level of unfamiliarity with a new technology, the higher the difficulty level. Technologies with high difficulty levels pose higher risks, thereby significantly impacting the performance, cost, and schedule of a project.

Finally, technologies that could be obtained through COTS were excluded from the list of CTE candidates (first round), and the final CTE was selected. Applying COTS technologies not only aligns with domestic acquisition policies, but



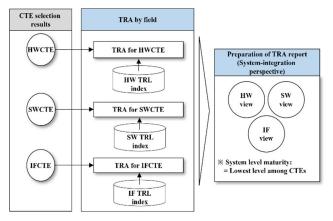


FIGURE 7. Procedure for TRA.

HW TRL	Definition	Validation environment	HW output			
1	Understanding the basic principles	Paper	-			
2	Formulation of technological concept	Paper	-			
3	Proof of concept	Laboratory	-			
4	Technology demonstration	Laboratory	Breadboard (low fidelity)			
5	Test-level HW demonstration	Laboratory	Brassboard (medium fidelity)			
6	Prototype-HW demonstration	Similar operating environment	Prototype (high fidelity)			
7	Integration and verification of the HW in the subsystem facility	Similar operating environment	Level of integration into subsystems			
8	Integration into the system and validated HW	Operational environment	Level of integration into the target system			
9	Proven operations	Operational environment	Level of integration into the target system			

FIGURE 8. HWTRLs.

also reduces the risks associated with a project by utilizing validated technologies.

The selected CTE was categorized as a hardware CTE (HWCTE), a software CTE (SWCTE), or an interface CTE (IFCTE).

C. ASSESSMENT OF TRLs

Evaluation of the TRL of the final CTE was performed based on the redefined hardware TRL (HWTRL), software TRL (SWTRL), and interface TRL (IFTRL) metrics, as illustrated in Fig. 7. Each TRL was redefined based on existing research and guidelines.

1) HWTRL

The HWTRL is a metric that evaluates the technological maturity of the HW. It was redefined based on the current nine-level TRL (Fig. 8) [4], [5], [6], [7].

Levels 1–3 and 9 remained unchanged. Levels 4 and 5 were defined based on the HW output levels and categorized as breadboard (low fidelity), brassboard (medium fidelity), and prototype (high fidelity).

SW TRL	Definition	Validation environment	SW output
0	Understanding the basic principles	Paper	
2	Basic principle coding	Paper, laboratory	Basic principle source code
3	SW component development	Laboratory	SW components
4	SW component integration	Laboratory	SW components
6	Prototype SW demonstration	Laboratory or similar operating environment	Prototype SW
6	Completion of the beta version SW	Similar operating environment	Beta version SW
7	Integration and verification of the SW in the test bed	Similar operating environment	Level of integration into the test bed
8	Integration into the system and validated SW	Operational environment	Level of integration into the target system
9	Proven operations	Operational environment	Level of integration into the target system

FIGURE 9. SWTRLs.

Level 6 represents the level of a completed prototype, level 7 indicates the integration and verification of the HW product at the subsystem level, and level 8 defines the completion of physical system integration at the system level with the completion of testing and evaluation.

2) SWTRL

The SWTRL is an indicator that is used to assess the technological maturity of SW. It was redefined as described in Fig. 9 [21], [22], [23].

Levels 1, 8, and 9 were redefined in terms of SW, as the levels in HWTRL have been in terms of HW. Level 2 represented the stage in which basic principles were coded, level 3 represented the development of the components, level 4 represented the integration of the components, level 5 involved the demonstration of a prototype, and level 6 signified the completion of the beta version with subsequent version management. At level 7, the SW functionality was integrated into a testbed and verified in a similar operating environment.

3) IFTRL

The IFTRL is a metric that is used to assess the maturity of IF technologies. It was redefined as depicted in Fig. 10 [7], [13].

Level 1 corresponded to the identification and definition of IF points based on operational concepts, whereas level 2 was the level at which the IF interactions were defined. Level 3 involved the completion of IF diagrams, including IF points, input/output relationships, and data.

Level 4 represented the detailed design level at which both the data communication and IF verification and management structures were established. Level 5 was the level at which the IF technology was demonstrated and level 6 was the level at which the prototype was demonstrated.



IF TRL	Definition	Validation environment	IF output			
0	Interface identification	Paper	-			
2	Interface interaction definition	Paper	-			
3	Preliminary interface design	Paper	-			
0	Detailed interface design	Paper	-			
6	Interface technology demonstration	Laboratory	Simulation SW			
6	Interface prototype demonstration	Similar operating environment	IF prototype			
0	Integration and validation of the IF in the test bed	Similar operating environment	Level of integration into the test bed			
8	Integration into the system and validated IF	Operational environment	Level of integration into the target system			
0	Proven operations	Operational environment	Level of integration into the target system			

FIGURE 10. IFTRLs.

Levels 7–9 represented subsystem integration and validation, completion of system-level IF development, and mission accomplishment, respectively.

The TRL evaluation team used the redefined HW/SW/IF TRLs to perform a TRA on the final selected CTE and report the results.

IV. CASE STUDY

A case study was conducted on three SoS using the proposed TRA framework. A technical WBS was developed, and CTE identification and TRA evaluation were performed using this framework.

The results of the case study of the target surveillance system (TSS) are presented in this section. The case study outcomes for the airfield damage assessment and recovery management system (ADARMS) and naval tactical data system (NTDS) are presented in the appendix.

A. OVERVIEW OF TSS

The TSS is a system that supports the rapid assessment and analysis of enemy movements using electro-optical/infrared (EO/IR) imagery.

It collects near real-time data from installed EO and IR sensors and promptly transmits them to the personnel overseeing the designated area.

Notably, the collected EO imagery supports automatic target detection based on artificial intelligence (AI). The system displays the collected EO and IR images on a digital map and provides the personnel with the capability to analyze them.

The key quantitative objective is to achieve a 5-s (assumption) timeframe for EO imagery collection and updates. The process diagram of the TSS in the case study is presented in Fig. 11.

The processes related to the key quantitative objectives involved target detection from EO sensors, data processing

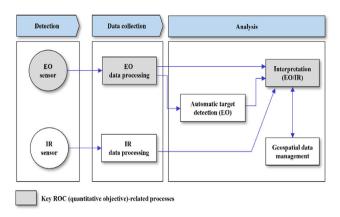


FIGURE 11. Processes in the working of the TSS.

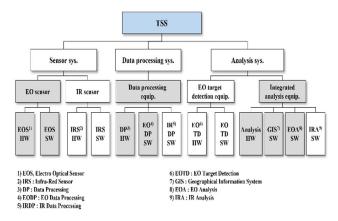


FIGURE 12. Technical WBS for TSS.

and manipulation, and displaying the targets on a map for user interpretation, each of which is marked separately.

B. CONSTRUCTION OF TECHNICAL WBS AND DERIVATION OF TES

The technical WBS for the TSS is depicted in Fig. 12.

In this study, the TSS was structured into sensor, data processing, and analysis systems. Each subsystem was further divided into components and HW/SW.

To derive the TE, the HWTE and SWTE required for developing the HW and SW items based on the technical WBS were identified.

Fifteen HWTEs/SWTEs, including the EO detector fabrication technology, were identified. Overall, the TEs included three EO sensors, three IR sensors, three pieces of data-processing equipment, two pieces of data target-detection equipment, and four pieces of integrated analysis equipment.

According to the system operational concept, we identified components (gray area) that are related to the key ROC quantitative objectives.

The obtained results are presented in the TE definition document in Fig. 13.

To identify the IFTE, the requirements were analyzed and the interrelationships between TSS components were



TBS				TE				
Level 2	Level 3	TE ID	Technology name	Technology definition				
		HWTE 1	EO detector	High-resolution EO detector fabrication technology				
Sensor sys.	EO sensor	HWTE 2	EO optical system	High-resolution EO optical system fabrication technology				
		SWTE 1	EO image processing firmware	EO image processing firmware technology				
		HWTE 3	TR detector	High-resolution IR detector fabrication technology				
	IR sensor	HWTE 4	IR optical system	High-resolution IR optical system fabrication technology				
		SWTE 2	IR image processing firmware	IR image processing firmware technology				
	D. (HWTE 5	CPU-based hardware production	High-performance CPU-based hardware production technology				
Data processing sys.	Data processing equip.	SWTE 3	EO image collection	EO metadata and image processing technology				
	equip.	SWTE 4	IR image collection	IR metadata and image processing technology				
	EO target	HWTE 6	GPU-based hardware	High-performance GPU-based hardware production technology				
	equip.	SWTE 5	AI-based image processing	AI-based automatic target detection technology				
Analysis sys.	Integrated	HWTE 7	CPU-based parallel processing	High-performance CPU-based parallel processing technology				
	analysis	SWTE 6	GIS technology	Location-based image mapping technology				
	equip.	SWTE 7	EO image analysis	EO image analysis and editing technology				
		SWTE 8	IR image analysis	IR image analysis and editing technology				

FIGURE 13. Definitions of HWTEs/SWTEs.

Technical WBS		EO sensor		IR sensor		Data processing equip.			EO target	detection equip.	Integrated analysis equip.			
Level 3	Level 4	EOS HW	EOS SW	IRS HW	IRS SW	DP HW	EODP SW	IRDP SW	EOTD HW	EOTD SW	Anaysis HW	GIS SW	EOA SW	IRA SW
FO	EOS HW		IFTE 1			IFTE 2								
EO sensor	EOS SW	IFTE 1					IFTE 3							
ID	IRS HW				IFTE 4	IFTE 5								
IR sensor	IRS SW			IFTE 4				IFTE 6						
Data	DP HW	IFTE 2		IFTE 5			IFTE 7	IFTE 8	IFTE 9		IFTE 11			
processing	EODP SW		IFTE 3			IFTE 7				IFTE 10			IFTE 12	
equip.	IRDP SW				IFTE 6	IFTE 8								IFTE 13
EO target detection	EOTD HW					IFTE 9				IFTE 14	IFTE 15			
equip.	EOTD SW						IFTE 10		IFTE 14				IFTE 16	
	Analysis HW					IFTE 11			IFTE 15			IFTE 17	IFTE 18	IFTE 19
Integrated	GIS SW										IFTE 17			
analysis equip.	EDA SW									IFTE 16	IFTE 18			
-1-4	IRA SW							IFTE 13			IFTE 19			

FIGURE 14. Identification results of IFTEs.

determined to identify the interfaces between each HW and SW item, as shown in Fig. 14. Overall, 19 IFTEs were identified as TSS components.

The identified IFTEs were documented and managed using the IFTE definition document for each IF segment, as shown in Fig. 15.

The segments needed to be non-overlapping and the IF specifications needed to be documented according to the type of IF: HW-HW IF, HW-SW IF, and SW-SW IF.

C. SELECTION OF CTES IN TSS

The HWTEs, SWTEs, and IFTEs that were identified in the previous step were considered as candidates for CTE selection.

Following the improved TRA framework, the TEs related to the primary ROC quantitative objectives were first identi-

Interfac	e section		IFTE
Titterrac	e section	TEID	Technology definition
	EO sensor	IFTE 1	EO data bus technology
EO sensor		IFTE 2	Gigabit optical communication technology (EO)
	Data processing equip.	IFTE 3	EO MTF technology
	IR sensor	IFTE 4	IR data bus technology
IR sensor		IFTE 5	Optical communication technology (IR)
	Data processing equip.	IFTE 6	IR MTF (Message Text Format) technology
	Data processing equip.	IFTE 7	DP-EO API (Application Programming Interface) technology
Data processing	cquip.	IFTE 8	DP-IR API technology
equip.	EO target detection	IFTE 9	Gigabit optical communication technology (EO/IR)
	equip.	IFTE 10	EODP-EOTD API technology
DP HW	Analysis HW	IFTE 11	Gigabit optical communication technology (EO/IR)
EODP SW	EOA SW	IFTE 12	Rest API (EODP-EDA)
IRDP SW	IRA SW	IFTE 13	Rest API (IRDP-IRA)
EOTD HW	EOTD SW	IFTE 14	Web-based middleware technology
EOIDHW	Analysis HW	IFTE 15	Gigabit optical communication technology (EO)
EOTD SW	EOA SW	IFTE 16	Rest API (EOTD-EDA)
	GIS SW	IFTE 17	GIS API
Analysis HW	EOA SW	IFTE 18	IAE-EDA API
	IRA SW	IFTE 19	IAE-IRA API

FIGURE 15. Definitions of IFTEs. MTF: message text format; API: application programming interface; DP–EO: data processing-electro optical; DP–IR: data processing-infrared; EODP–EOTD: electro-optical data processing-electro-optical target detection.

	Identification results related to the key R (Quantitative objective)	Difficulty	Application	
TE ID	Technology definition	level	of COTS	
HWTE 1	High-resolution EO detector fabrication technology	•	N/A	•
HWTE 2	High-resolution EO optical system fabrication technology	•	N/A	×
HWTE 3	High-resolution IR detector fabrication technology	×	4	•
HWTE 5	High-performance CPU-based hardware production technology	•	N/A	•
HWTE 6	High-performance GPU-based hardware production technology	×	5	•
HWTE 7	High-performance CPU-based parallel processing technology	•	N/A	•
SWTE 1	EO image processing firmware technology	•	N/A	×
SWTE 3	EO metadata and image processing technology	•	N/A	×
SWTE 5	Al-based automatic target detection technology	×	4	×
SWTE 6	Location-based image mapping technology	•	N/A	×
SWTE 7	EO image analysis and editing technology	•	N/A	×
IFTE 1	EO data bus technology	•	N/A	•
IFTE 2	Gigabit optical communication technology (EO)	•	N/A	•
IFTE 3	EO MTF technology	•	N/A	×
IFTE 4	IR data bus technology	×	4	•
IFTE 7	DP-EO API (Application Programming Interface) technology	•	N/A	×
IFTE 11	Gigabit optical communication technology (EO/IR)	•	N/A	•
IFTE 12	Rest API (EODP-EDA)	•	N/A	•
IFTE 17	GIS API	•	N/A	•
IFTE 18	IAE-EDA API	•	N/A	×

FIGURE 16. Filtered results for CTE selection.

fied. A process diagram was generated based on the system's operational concept and the core processes related to the key ROC quantitative objectives were identified. Using the



TABLE 1. Technical work breakdown structure (WBS) for airfield damage assessment and recovery management system (ADARMS).

Level 1	Level 2	Level 3	Level 4	Key ROC allocation
			AP HW	
			AV HW	
			FC SW	
		UAV platform	NV SW	
			PS HW	
			CM HW	•
	Damage information		CM SW	•
	collection system		EO HW	•
	concetion system	Payload equipment	EO SW	•
		1 ay load equipment	IR HW	
			IR SW	•
			DL HW	•
ADARMS		Ground control	DL SW	•
		equipment	GC HW	
			GC SW	
			IP HW	•
		Image processing	GW SW	•
		equipment	2D_EO IP SW	•
	Damage assessment	equipment	2D_IR IP SW	•
	system		3D_IP SW	
		Damaga assassment	DA HW	•
		Damage assessment equipment	DA SW	•
		equipment	MS SW	
	Damage recovery	DRM equipment	DRM HW	
	management system	DKW equipment	DRM SW	

AP: Airframe and propulsion system; AV: Avionics; FC: Flight control; NV: Navigation; PS: Platform sensor; CM: Communication; EO: Electro-optical; IR: Infrared; DL: Data link; GC: Ground control; IP: Image processing; GW: Gateway; DA: Damage assessment; MS: Minimum operate stripe selection; DRM: Damage recovery management.

	СТЕ		Results of TRA
CTEID	Name	TRL	Reference
HWCTE 1	High-resolution EO optical system fabrication technology	6	EOTS project for ships (experience in EO optical system design and prototype production)
SWCTE 1	EO image processing firmware technology	6	EOTS project for ships (experience in EO optical system design and prototype production)
SWCTE 2	EO metadata and image processing technology		EOTS project for ships (experience in EO optical system design and prototype production)
SWCTE 3	AI-based automatic target detection technology	5	Critical technology research and development project of automatic target detection using EO images
SWCTE 4	Location-based image mapping technology	7	O-class UAV project (experience in image mapping technology)
SWCTE 5	EO image analysis and editing technology	7	O-class UAV project (experience in image analysis and editing technology)
IFCTE 1	EO MTF technology	8	M-project (experience in processing EO images with MTF)
IFCTE 2	DP-EO API technology	7	O-class UAV project (experience in image analysis and editing technology)
IFCTE 3	IAE-EOA API technology	7	O-class UAV project (experience in image analysis and editing technology)

FIGURE 17. Results of TRA. EOTS: electro-optical tracking system; UAV: unmanned aerial vehicle; IAE–EOA: integrated analysis equipment–electro-optical analysis.

WBS, we identified the HW and SW configuration items relevant to these core processes. The identified items and the corresponding mapped TEs represent TEs related to the key ROC quantitative objectives. Additionally, by utilizing the interface matrix, we identified the interrelationships associ-

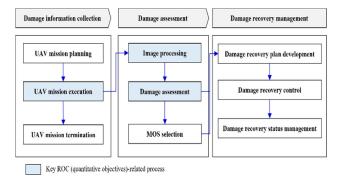


FIGURE 18. Processes in the working of a ADARMS.

ated with the core processes. These TEs included HWTEs (four items), SWTEs (four items), and IFTEs (eight items).

Thereafter, a difficulty evaluation was conducted among the TEs that were unrelated to the primary ROC quantitative objectives. Four TEs, including high-resolution IR detector fabrication technology, with difficulty levels of four or higher were identified.

Finally, 11 technologies that could be obtained through COTS technologies, such as high-performance CPU-based HW production technology, were excluded from the list of CTEs.



TABLE 2. Definitions of ADARMS HWTEs and SWTEs.

T	BS			TE
Level 2	Level 3	TE ID	Technology name	Technology definition
		HWTE 1	Airframe and propulsion	Airframe and propulsion system design and
			HW	manufacturing technology (fuselage, wings, rotors, etc.)
	UAV platform	HWTE 2	Avionics HW	Avionics HW design and manufacturing technology
		SWTE 1	Flight control SW	Flight control SW technology
		SWTE 2	Navigation SW	Navigation SW technology
		HWTE 3	Platform sensors	Platform sensor design and integration technology (GPS, IMU, altitude sensor, etc.)
		HWTE 4	Communication HW	Communication HW technology (data link, bus, etc.)
Damage		SWTE 3	Communication SW	Communication SW technology
information		HWTE 5	EO camera	EO camera design and integration technology
collection	Payload	SWTE 4	EO image processing SW	EO image processing SW technology
system	equipment	HWTE 6	IR camera	IR camera design and integration technology
		SWTE 5	IR image processing SW	IR image processing SW technology
		HWTE 7	Data link HW (GCS)	Communication module design and manufacturing technology
	Ground	SWTE 6	Data link SW (GCS)	Data link SW technology
	control	HWTE 8	Remote control HW	Remote control HW technology for GCS
	equipment	SWTE 7	Mission planning SW	Mission planning SW technology
		SWTE 8	Diagnostics and monitoring SW	UAV diagnostics and monitoring SW technology
		HWTE 9	IP HW	High-performance GPU-based HW production technology
		SWTE 9	Gateway SW	Gateway SW technology
	Image processing	SWTE 10	2D_EO IP SW (SYS)	2D EO image processing SW technology (image mapping, etc.)
5	equipment	SWTE 11	2D_IR IP SW	2D IR image processing SW technology (image mapping, etc.)
Damage assessment		SWTE 12	3D_IP SW	3D IR image processing SW technology (DSM, point cloud, etc.)
system		HWTE 10	DA HW	High-performance CPU-based HW production technology
	Damage	SWTE 13	Damage detection	AI-based damage detection SW technology
	assessment	SWTE 14	Damage recognition	AI-based damage recognition SW technology
	equipment	SWTE 15	Calculate damage scale	Automatic damage calculation SW technology
		SWTE 16	MOS selection SW	Automatic MOS candidate recommendation SW technology
_	_	HWTE 11	DRM HW	High-performance CPU-based HW production technology
Damage	Damage	SWTE 17	Resource management SW	Resource management SW technology
recovery	recovery	SWTE 18	Decision support SW	Decision support SW technology
management system	management equipment	SWTE 19	Communication and coordination SW	Real-time communication and coordination SW technology
		SWTE 20	Situation monitoring SW	Situation monitoring SW technology (GIS integration)
	I	222		i

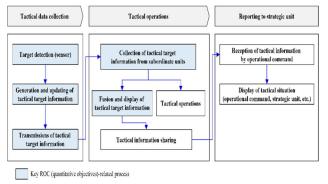


FIGURE 19. Processes in the working of a NTDS.

The filtered results for the CTEs based on the identified TEs are summarized in Fig. 16. Finally, nine CTEs were

selected, including the high-resolution EO optical system fabrication technology.

D. ASSESSMENT OF TRLS FOR TSS

The TRA was performed based on the redefined HWTRL, SWTRL, and IFTRL in the improved TRA framework. The results are presented in Fig. 17. The system-level TRL of the TSS was 5.

V. CONCLUSION

This study has proposed a framework that solves the limitations of TRA from an SE perspective. Although maximizing the utilization of the existing research results was one of the objectives, the focus was on methodological improvements.



TABLE 3. Identification Results of ADARMS IFTEs.

TBS					UAV					Payl			(l contro	ol
	1	platform AP AV FC NV PS CM CM							EO	equip:	ment IR	IR	DL	equip DL	oment GC	GC
Level 3	Level 4	HW	HW	SW	SW	HW	HW	SW	HW	SW	HW	SW	HW	SW	HW	sw
	AP HW		IFTE 1													
	AV HW	IFTE 1		IFTE 2	IFTE 3		IFTE 4									
	FC SW		IFTE 2		IFTE 5			IFTE 6								
UAV platform	NV SW		IFTE 3	IFTE 5				IFTE 7								
piatroim	PS HW						IFTE 8									
	CM HW		IFTE 4			IFTE 8		IFTE 9	IFTE 10		IFTE 11		IFTE 12			
	CM SW			IFTE 6	IFTE 7		IFTE 9			IFTE 13		IFTE 14		IFTE 15		
	EO HW						IFTE 10			IFTE 14						
Payload	EO SW							IFTE 13	IFTE 14							
equipment	IR HW						IFTE 11					IFTE 16				
	IR SW							IFTE 14			IFTE 16					
	DL HW						IFTE 12							IFTE 17	IFTE 18	
Ground	DL SW							IFTE 15					IFTE 17			IFTE 20
control equipment	GC HW												IFTE 18			IFTE 22
1	GC SW													IFTE 20	IFTE 22	
	IP HW												IFTE 19			
T	GW SW													IFTE 21		
Image processing	2D_EO IP SW															
equipment	2D_IR IP SW															
	3D IP															
Damage	SW DA HW															
assessment	DA SW															
equipment	MS SW															
Damage	DRM															
recovery	HW															
management equipment	DRM SW															

TBS		Image processing equipment					Damage assessment equipment			Damage recovery management equipment	
Level 3	Level4	IP HW	GW SW	2D_EO IP SW	2D_IR IP SW	3D_IP SW	DA HW	DA SW	MS SW	DRM HW	DRM SW
	AP HW	1111	511	11 511	1 5 ()	511	22.11	5.,	5,,	1117	517
	AV HW										
UAV	FC SW										
	NV SW										
platform	PS HW										
	CM HW										
	CM SW										
	EO HW										
Payload	EO SW										
equipment	IR HW										
11	IR SW										
Ground	DL HW	IFTE 19									
	DL SW		IFTE 21								
control	GC HW										
equipment	GC SW										
	IP HW		IFTE 23	IFTE 24	IFTE 25	IFTE 26	IFTE 27			IFTE 28	
	GW SW	IFTE 23		IFTE 29	IFTE 30	IFTE 31		IFTE 32	IFTE 33		IFTE 34
Image processing equipment	2D_EO IP SW	IFTE 24	IFTE 29								
	2D_IR IP SW	IFTE 25	IFTE 30								
	3D_IP SW	IFTE 26	IFTE 31								
	DA HW	IFTE 27						IFTE 35	IFTE 36	IFTE 37	



TABLE 3. (Continued.) Identification Results of ADARMS IFTEs.

TBS		Image processing equipment			Damage assessment equipment			Damage recovery management			
Level 3	Level4	IP HW	GW SW	2D_EO IP SW	2D_IR IP SW	3D_IP SW	DA HW	DA SW	MS SW	DRM HW	DRM SW
Damage	DA SW		IFTE 32				IFTE 35		IFTE 38		
assessment equipment	MS SW		IFTE 33				IFTE 36	IFTE 38			
Damage	DRM HW	IFTE 28					IFTE 37				IFTE 39
recovery management equipment	DRM SW		IFTE 34							IFTE 39	

TABLE 4. Definitions of ADARM IFTEs.

Inter	Interface section		IFTE				
	BS level 4)	TE ID	Technology definition				
AP HW	AV HW	IFTE 1	Control system design and integration technology				
	FC SW	IFTE 2	FC data bus technology				
AV HW	NV SW	IFTE 3	NV data bus technology				
	CM HW	IFTE 4	AV-CM standard interface technology				
FC SW	NV SW	IFTE 5	FC-NV API technology				
rcsw	CM SW	IFTE 6	FC-CM API technology				
NV SW	CM SW	IFTE 7	NV-CM API technology				
PS HW	CM HW	IFTE 8	PS-CM standard interface technology				
	CM SW	IFTE 9	Communication firmware technology				
CM HW	EO HW	IFTE 10	CM-EO standard interface technology				
CIVI II W	IR HW	IFTE 11	CM-IR standard interface technology				
	DL HW	IFTE 12	Standard data link construction technology				
	EO SW	IFTE 13	CM-EO API technology				
CM SW	IR SW	IFTE 14	CM-IR API technology				
	DL SW	IFTE 15	CM-DL API technology				
IR HW	IR SW	IFTE 16	IR firmware technology				
	DL SW	IFTE 17	DL standard firmware technology				
DL HW	GC HW	IFTE 18	DL-GC standard interface technology				
	IP HW	IFTE 19	Standard data link construction technology				
DI CW	GC SW	IFTE 20	DL-GC API technology				
DL SW	GW SW	IFTE 21	DL standard protocol technology				
GC HW	GC SW	IFTE 22	GC firmware technology				
	GW SW	IFTE 23	Web based middleware technology				
	2D_EO IP SW	IFTE 24	Web based middleware technology				
IP HW	2D_IR IP SW	IFTE 25	Web based middleware technology				
IPHW	3D_IP SW	IFTE 26	Web based middleware technology				
	DA HW	IFTE 27	Gigabit optical communication technology				
	DRM HW	IFTE 28	Gigabit optical communication technology				
	2D EO IP SW	IFTE 29	Rest API technology				
	2D_IR IP SW	IFTE 30	Rest API technology				
CWCW	3D IP SW	IFTE 31	Rest API technology				
GW SW	DA SW	IFTE 32	Rest API technology				
	MS SW	IFTE 33	Rest API technology				
	DRM SW	IFTE 34	Rest API technology				
	DA SW	IFTE 35	Web-based middleware technology				
DA HW	MS SW	IFTE 36	Web-based middleware technology				
	DRM HW	IFTE 37	Gigabit optical communication technology				
DA SW	MS SW	IFTE 38	API and DBMS technology				
DRM HW	DRM SW	IFTE 39	Web-based middleware technology				

The proposed framework provides detailed procedures and deliverables for system-integration-oriented TRA.

The effectiveness of this framework was confirmed through a case study using three SoS (TSS, ADARMS, and NTDS). Experts with experience in SE-based defense R&D

can easily understand and apply this framework. It enables systematic and comprehensive identification of TEs as it first determines the HWTEs and SWTEs from the technical WBS and then the IFTEs through the IF relationships of the system components.



TABLE 5. Key ROC quantitative objective-related HWTEs/SWTEs.

TBS			Key ROC-related	
Level 2 Level 3		TE ID	items	
		HWTE 1	Airframe and propulsion system design and manufacturing technology (fuselage, wings, rotors, etc.)	×
		HWTE 2	Avionics HW design and manufacturing technology	×
		SWTE 1	Flight control SW technology	×
	UAV platform	SWTE 2	Navigation SW technology	×
		HWTE 3	Platform sensor design and integration technology (GPS, IMU, altitude sensor, etc.)	×
		HWTE 4	Communication HW technology (data link, bus, etc.)	•
D		SWTE 3	Communication SW technology	•
Damage information		HWTE 5	EO camera design and integration technology	•
collection system	Payload	SWTE 4	EO image processing SW technology	•
	equipment	HWTE 6	IR camera design and integration technology	•
		SWTE 5	IR image processing SW technology	•
	Ground control equipment	HWTE 7	Communication module design and manufacturing technology	•
		SWTE 6	Data link SW technology	•
		HWTE 8	Remote control HW technology for GCS	×
		SWTE 7	Mission planning SW technology	×
		SWTE 8	UAV diagnostics and monitoring SW technology	×
		HWTE 9	High-performance GPU-based HW production technology	•
		SWTE 9	Gateway SW technology	•
	Image processing	SWTE 10	2D EO image processing SW technology (2D EO mapping, etc.)	•
	equipment	SWTE 11	2D IR image processing SW technology (2D IR mapping, etc.)	•
Damage assessment system		SWTE 12	3D IR image processing SW technology (DSM, point cloud, etc.)	×
system		HWTE10	High-performance CPU-based HW production technology	•
	Damage	SWTE 13	AI-based damage detection SW technology	•
	assessment	SWTE 14	AI-based damage recognition SW technology	•
	equipment	SWTE 15	Automatic damage calculation SW technology	×
		SWTE 16	Automatic MOS candidate recommendation SW technology	×
		HWTE 11	High-performance CPU-based HW production technology	×
Damage recovery	Damage recovery	SWTE 17	Resource management SW technology	×
management	management	SWTE 18	Decision support SW technology	×
system	equipment	SWTE 19	Real time communication and coordination SW technology	×
		SWTE 20	Situation monitoring SW technology (GIS integration)	×

In terms of CTE selection, the intuitive process of identifying TEs relating to the key ROC quantitative objectives is highly practical. These elements can be easily identified by analyzing the data flow according to operational concepts

and assigning key ROC quantitative objectives to the system components. Furthermore, the clear differences between levels make it easier to assess the technical difficulty. The decision regarding the application of COTS technology can



TABLE 6. Key ROC quantitative objective-related IFTEs.

Interface section			IFTE	V DOCl-t-12t	
(TI	BS level 4)	TE ID	Technology definition	Key ROC-related items	
AP HW	AV HW	IFTE 1	Control system design and integration technology	×	
	FC SW	IFTE 2	FC data bus technology	×	
AV HW	NV SW	IFTE 3	NV data bus technology	×	
	CM HW	IFTE 4	AV-CM Standard interface technology	×	
FC SW	NV SW	IFTE 5	FC-NV API technology	×	
FC SW	CM SW	IFTE 6	FC-CM API technology	×	
NV SW	CM SW	IFTE 7	NV-CM API technology	×	
PS HW	CM HW	IFTE 8	PS-CM Standard interface technology	×	
	CM SW	IFTE 9	Communication firmware technology	•	
CM HIM	EO HW	IFTE 10	CM-EO Standard interface technology	•	
CM HW	IR HW	IFTE 11	CM-IR Standard interface technology	•	
	DL HW	IFTE 12	CM-DL Standard interface technology	•	
	EO SW	IFTE 13	CM-EO API technology	•	
CM SW	IR SW	IFTE 14	CM-IR API technology	•	
	DL SW	IFTE 15	CM-DL API technology	•	
IR HW	IR SW	IFTE 16	IR firmware technology	•	
	DL SW	IFTE 17	DL standard firmware technology	•	
DL HW	GC HW	IFTE 18	DL-GC standard interface technology	×	
	IP HW	IFTE 19	Standard data link construction technology	•	
DL SW	GC SW	IFTE 20	DL-GC API technology		
DL SW	GW SW	IFTE 21	DL standard protocol technology	•	
GC HW	GC SW	IFTE 22	GC firmware technology		
	GW SW	IFTE 23	Web-based middleware technology	•	
	2D EO IP SW	IFTE 24	Web-based middleware technology	•	
IP HW	2D_IR IP SW	IFTE 25	Web-based middleware technology	•	
IPHW	3D_IP SW	IFTE 26	Web-based middleware technology	×	
	DA HW	IFTE 27	Gigabit optical communication technology	×	
	DRM HW	IFTE 28	Gigabit optical communication technology	×	
	2D_EO IP SW	IFTE 29	Rest API technology	×	
	2D_IR IP SW	IFTE 30	Rest API technology	×	
GW SW	3D_IP SW	IFTE 31	Rest API technology	×	
GWSW	DA SW	IFTE 32	Rest API technology	×	
	MS SW	IFTE 33	Rest API technology	×	
	DRM SW	IFTE 34	Rest API technology	×	
	DA SW	IFTE 35	Web-based middleware technology	×	
DA HW	MS SW	IFTE 36	Web-based middleware technology	×	
	DRM HW	IFTE 37	Gigabit optical communication technology	×	
DA SW	MS SW	IFTE 38	API & DBMS technology	×	
DRM HW	DRM SW	IFTE 39	Web-based middleware technology	×	

be easily determined by confirming the evidence for its sale and operation. Applying COTS technology not only reduces the cost of acquiring weapon systems but is also advantageous in terms of future system expandability and maintenance.

The proposed framework adopts the system-integration perspective for the evaluation and examined the TRA targets from the HW, SW, and IF perspectives. The implementation of TRLs that are redefined from these three perspectives does not pose significant difficulties in practical applications compared with the conventional approach.

The redefinition of the TRL in terms of HW, SW, and IF along with the provision of output formats as supplementary indicators of the TRL help to determine the maturity level of the corresponding technologies in the TRL.

Overall, the TRL is a useful communication tool for technological maturity. Technology evaluation is ultimately

performed by experts; therefore, if the TRL is straightforward and the boundaries of each stage are clear, TRA will become significantly more seamless and intuitive, thereby minimizing potential disagreements regarding the results. This study should contribute to future research on the evaluation criteria and procedures for TRA from a system-integration perspective.

In the future, we aim to enhance the completeness of the proposed framework by incorporating diverse perspectives from relevant experts on the methodological level. Our subsequent goal is to institutionalize this framework within the ROK military weapons system-acquisition process. This will involve developing a software tool that allows TRA evaluators to conduct assessments easily and intuitively and manage the results. Thus, we would streamline the integration of the framework into defense-acquisition procedures. This



TABLE 7. Difficulty evaluation results for HWTEs and SWTEs.

T	BS		TE	Key ROC-	Difficulty	Reference project	
Level 2	Level 3	TE ID	Technology definition	related items	level		
		HWTE 1	Airframe and propulsion system design and manufacturing technology (fuselage, wings, rotors, etc.)	×	2	H-UAV, M-UAV project	
		HWTE 2	Avionics HW design and manufacturing technology	×	2	H-UAV, M-UAV project	
D	UAV platform	SWTE 1	Flight control SW technology	×	2	H-UAV, M-UAV project	
Damage information		SWTE 2	Navigation SW technology	×	2	H-UAV, M-UAV project	
collection system		HWTE 3	Platform sensor design and integration technology (GPS, IMU, altitude sensor, etc.)	×	2	H-UAV, M-UAV project	
	Ground control equipment	HWTE 8	Remote control HW technology for GCS	×	2	H-UAV, M-UAV project	
		SWTE 7	Mission planning SW technology	×	2	H-UAV, M-UAV project	
		SWTE 8	UAV diagnostics and monitoring SW technology	×	2	H-UAV, M-UAV project	
Damage assessment	Image processing equipment	SWTE 12	3D IR image processing SW technology (DSM, point cloud, etc.)	×	3	M-project, A-R&D project	
system	Damage assessment	SWTE 15	Automatic damage calculation SW technology	×	4	A-R&D project	
	equipment	SWTE 16	Automatic MOS candidate recommendation SW technology	×	4	A-R&D project	
		HWTE 11	High-performance CPU-based HW production technology	×	5	M-project	
Damage	Damage	SWTE 17	Resource management SW technology	×	3	A-C4I project	
recovery	recovery	SWTE 18	Decision support SW technology	×	3	A-C4I project	
management system	management equipment	SWTE 19	Real-time communication and coordination SW technology	×	2	A-C4I project	
		SWTE 20	Situation monitoring SW technology (GIS integration)	×	2	A-C4I project	

software tool will be designed to facilitate TRA execution, ensuring that the process aligns with the proposed framework. Moreover, it will enable effective results management, thereby improving the overall efficiency and effectiveness of the TRA process in terms of weapons-system acquisition.

APPENDIX CASE STUDY RESULTS

The following case study was conducted to validate the effectiveness of the technology readiness assessment (TRA) framework for complex weapon systems from a systems-integration perspective. We selected systems that met the following two criteria as the subjects of the case study. First, the targeted systems should be a system of systems (SoS). They should not exist independently but should be

a complex system (SoS) that interfaces to a higher-level command-and-control system such as the C4I system. Second, the research team must have a substantial understanding of the targeted systems as it has direct involvement in research and development (R&D), or system development projects related to those weapons systems. We ultimately selected the airfield damage assessment and recovery management system (ADARMS) and naval tactical data system (NTDS) as systems that met both criteria. Subsequently, we conducted the case study according to the proposed framework and present the results in this document. Through these case studies, we confirmed the practicability and substantial practical value of this framework. The case studies were focused on the core aspects of the system, excluding any information related to military security.



TABLE 8. Difficulty evaluation results for IFTEs.

Interfa	Interface section		IFTE	Difficulty	Defenence project	
(TBS	S level 4)	TE ID	Technology definition	level	Reference project	
AP HW	AV HW	IFTE 1	Control system design and integration technology	2	H-UAV, M-UAV project	
	FC SW	IFTE 2	FC data bus technology	2	H-UAV, M-UAV project	
AV HW	NV SW	IFTE 3	NV data bus technology	2	H-UAV, M-UAV project	
	CM HW	IFTE 4	AV-CM standard interface technology	2	H-UAV, M-UAV project	
FC SW	NV SW	IFTE 5	FC-NV API technology	2	H-UAV, M-UAV project	
rc sw	CM SW	IFTE 6	FC-CM API technology	2	H-UAV, M-UAV project	
NV SW	CM SW	IFTE 7	NV-CM API technology	2	H-UAV, M-UAV project	
PS HW	CM HW	IFTE 8	PS-CM standard interface technology	2	H-UAV, M-UAV project	
DL HW	GC HW	IFTE 18	DL-GC standard interface technology	1	H-UAV, M-UAV project	
DL SW	GC SW	IFTE 20	DL-GC API technology	2	H-UAV, M-UAV project	
GC HW	GC SW	IFTE 22	GC firmware technology	2	H-UAV, M-UAV project	
	3D_IP SW	IFTE 26	Web-based middleware technology	2	M-project, A-C4I project	
IP HW	DA HW	IFTE 27	Gigabit optical communication technology	1	M-project, A-C4I project	
	DRM HW	IFTE 28	Gigabit optical communication technology	1	M-project, A-C4I project	
	2D_EO IP SW	IFTE 29	Rest API technology	2	M-project	
	2D_IR IP SW	IFTE 30	Rest API technology	2	M-project	
GW SW	3D_IP SW	IFTE 31	Rest API technology	2	M-project	
Gwsw	DA SW	IFTE 32	Rest API technology	2	M-project	
	MS SW	IFTE 33	Rest API technology	2	M-project	
	DRM SW	IFTE 34	Rest API technology	2	M-project	
	DA SW	IFTE 35	Web-based middleware technology	2	M-project, A-C4I project	
DA HW	MS SW	IFTE 36	Web-based middleware technology	2	M-project, A-C4I project	
BITTI	DRM HW	IFTE 37	Gigabit optical communication technology	1	M-project, A-C4I project	
DA SW	MS SW	IFTE 38	API and DBMS technology	2	M-project, A-C4I project	
DRM HW	DRM SW	IFTE 39	Web-based middleware technology	2	M-project, A-C4I project	

VI. ADARMS

A. OVERVIEW OF ADARMS

The ADARMS aims to ensure the continuity of aviation operations by providing a management system for rapid damage recovery in runways at airfields during both peacetime and wartime. The core operational concept of the system is illustrated in Fig. 18.

The damage assessment team operated unmanned aerial vehicles (UAVs) equipped with electro-optical/infrared (EO/IR) sensors to capture images of damage on a runway at an airfield. Subsequently, this imagery was transmitted to a central control center via a wireless communication network. The system utilized the EO/IR imagery collected via a wireless communication system to automatically classify the damage types and determine the locations and extent of damage. The commander utilized the damage analysis results to review the minimum operate stripe (MOS) recommended by the system and ultimately selected the MOS. Subsequently, they swiftly established a recovery plan and shared it with the troubleshoot team. The commander utilized the system to communicate with the recovery team members

on site, controlling the runway damage repair and managing the progress status.

The key required operational capability (ROC) quantitative objective was to automatically recognize and classify the types of airfield damage (such as cracks, depressions, etc.) within 20 min (assumption) by collecting and analyzing imagery captured by UAVs.

B. DEVELOPMENT OF TECHNICAL WORK BREAKDOWN STRUCTURE

The results of the technical work breakdown structure (WBS) for the ADARMS are presented in Table 1.

The system was broken down into damage information collection, assessment, and recovery management systems. The damage assessment system consisted of a platform, payload, and ground control equipment for operating UAVs.

The damage assessment system was divided into image processing equipment, which performs 2D/3D mapping using imagery captured by UAVs, and damage assessment equipment, which automatically classifies damage types, calculates damage extents, and recommends the MOS. The



TABLE 9. Selection of CTE candidates (first).

	TE	Key ROC-related items	Difficulty	
TE ID	Technology definition	Rey Roe-related items	level	
HWTE 4	Communication HW technology (data link, bus, etc.)	•		
HWTE 5	EO camera design and integration technology	•		
HWTE 6	IR camera design and integration technology	•		
HWTE 7	Communication module design and manufacturing technology	•		
HWTE 9	High-performance GPU-based HW production technology	•		
HWTE 10	High-performance CPU-based HW production technology	•		
HWTE 11	High-performance CPU-based HW production technology	×	5	
SWTE 3	Communication SW technology	•		
SWTE 4	EO image processing SW technology	•		
SWTE 5	IR image processing SW technology	•		
SWTE 6	Data link SW technology	•		
SWTE 9	Gateway SW technology	•		
SWTE 10	2D EO image processing SW technology (2D EO mapping, etc.)	•		
SWTE 11	2D IR image processing SW technology (2D IR mapping, etc.)	•		
SWTE 13	AI-based damage detection SW technology	•		
SWTE 14	AI-based damage recognition SW technology	•		
SWTE 15	Automatic damage calculation SW technology	×	4	
SWTE 16	Automatic MOS candidate recommendation SW technology	×	4	
IFTE 9	Communication firmware technology	•		
IFTE 10	CM-EO standard interface technology	•		
IFTE 11	CM-IR standard interface technology	•		
IFTE 12	CM-DL standard interface technology	•		
IFTE 13	CM-EO API technology	•		
IFTE 14	CM-IR API technology	•		
IFTE 15	CM-DL API technology	•		
IFTE 16	IR firmware technology	•		
IFTE 17	DL standard firmware technology	•		
IFTE 19	Standard data link construction technology	•		
IFTE 21	DL standard protocol technology	•		
IFTE 22	GC firmware technology			
IFTE 23	Web-based middleware technology	•		
IFTE 24	Web-based middleware technology	•		
IFTE 25	Web-based middleware technology	•		

damage recovery-management system is responsible for establishing and controlling the damage recovery plan.

According to the system operational concept, we identified components related to the key ROC quantitative objectives. Configuration items related to sharing images captured by UAVs using EO/IR sensors and conducting two-dimensional (2D) mapping were identified. Additionally, hardware (HW) and software (SW) configuration items related to automatically detecting and classifying damage types from collected imagery were identified.

C. SELECTION OF CTES

1) IDENTIFICATION OF TECHNICAL ELEMENTS (TEs)

a: IDENTIFICATION OF HWTEs and SWTEs

The HWTEs and SWTEs identified based on the WBS of the ADARMS are summarized in Table 2.

TEs were identified and defined as the TEs necessary for developing HW and SW items corresponding to WBS Level 4.

For HWTE, eight elements were identified for the damage information collection system, two elements for the damage assessment system, and one element for the damage recovery management system. For SWTE, eight elements were identified for the damage information collection system, eight elements for the damage assessment system, and four elements for the damage recovery management system.

b: IDENTIFICATION OF IFTES

According to the operational concept of the ADARMS, 39 interface TEs (IFTEs) were identified, which are summarized in Table 3.



TABLE 10. List of CTE candidates (first).

CTE candidate ID	CTE candidate (1st)	TE ID
C-HWCTE 1	Communication HW technology (data link, bus, etc.)	HWTE 4
C-HWCTE 2	EO camera design and integration technology	HWTE 5
C-HWCTE 3	IR camera design and integration technology	HWTE 6
C-HWCTE 4	Communication module design and manufacturing technology	HWTE 7
C-HWCTE 5	High-performance GPU-based HW production technology	HWTE 9
C-HWCTE 6	High-performance CPU-based HW production technology	HWTE 10
C-HWCTE 7	High-performance CPU-based HW production technology	HWTE 11
C-SWCTE 1	Communication SW technology	SWTE 3
C-SWCTE 2	EO image processing SW technology	SWTE 4
C-SWCTE 3	IR image processing SW technology	SWTE 5
C-SWCTE 4	Data link SW technology	SWTE 6
C-SWCTE 5	Gateway SW technology	SWTE 9
C-SWCTE 6	2D EO image processing SW technology (2D EO mapping, etc.)	SWTE 10
C-SWCTE 7	2D IR image processing SW technology (2D IR mapping, etc.)	SWTE 11
C-SWCTE 8	AI-based damage detection SW technology	SWTE 13
C-SWCTE 9	AI-based damage recognition SW technology	SWTE 14
C-SWCTE 10	Automatic damage calculation SW technology	SWTE 15
C-SWCTE 11	Automatic MOS candidate recommendation SW technology	SWTE 16
C-IFCTE 1	Communication firmware technology	IFTE 9
C-IFCTE 2	CM-EO standard interface technology	IFTE 10
C-IFCTE 3	CM-IR standard interface technology	IFTE 11
C-IFCTE 4	CM-DL standard interface technology	IFTE 12
C-IFCTE 5	CM-EO API technology	IFTE 13
C-IFCTE 6	CM-IR API technology	IFTE 14
C-IFCTE 7	CM-DL API technology	IFTE 15
C-IFCTE 8	IR firmware technology	IFTE 16
C-IFCTE 9	DL standard firmware technology	IFTE 17
C-IFCTE 10	Standard data link construction technology	IFTE 19
C-IFCTE 11	DL standard protocol technology	IFTE 21
C-IFCTE 12	GC firmware technology	IFTE 22
C-IFCTE 13	Web-based middleware technology	IFTE 23
C-IFCTE 14	Web-based middleware technology	IFTE 24
C-IFCTE 15	Web-based middleware technology	IFTE 25

By tracking the data flow in the operational concept, we identified the interrelationships between HW and SW configuration items.

Table 4 summarizes the definitions of the identified IFTEs. It defines the necessary technology for IFs between the HW and SW configuration items.

2) SELECTION OF CTE CANDIDATES (FIRST)
a: IDENTIFICATION OF TES RELATED TO KEY ROC
QUANTITATIVE OBJECTIVES

The HWTEs and SWTEs related to the key ROC quantitative objectives were identified (Table 5).

The method to identify the TEs related to the key ROC quantitative objectives was as follows: a process diagram was generated based on the system's operational concept and the core processes related to the key ROC quantitative objectives were identified.

The WBS was used to identify the HW and SW configuration items involved in handling the identified core processes. The TEs mapped to these items were related to the key ROC quantitative objectives.

Fig. 18 illustrates the operational concept of the ADARMS represented with a high-level process diagram. According to the mission plan, UAVs utilized the onboard EO/IR to capture images of damaged areas and transmit them to the control center.



TABLE 11. Determination of COTS technology application.

CTE candidate ID	CTE candidate (1st)	Application of COTS
C-HWCTE 1	Communication HW technology (data link, bus, etc.)	•
C-HWCTE 2	EO camera design and integration technology	•
C-HWCTE 3	IR camera design and integration technology	•
C-HWCTE 4	Communication module design and manufacturing technology	•
C-HWCTE 5	High-performance GPU-based HW production technology	•
C-HWCTE 6	High-performance CPU-based HW production technology	•
C-HWCTE 7	High-performance CPU-based HW production technology	•
C-SWCTE 1	Communication SW technology	•
C-SWCTE 2	EO image processing SW technology	•
C-SWCTE 3	IR image processing SW technology	•
C-SWCTE 4	Data link SW technology	•
C-SWCTE 5	Gateway SW technology	•
C-SWCTE 6	2D EO image processing SW technology (2D EO mapping, etc.)	×
C-SWCTE 7	2D IR image processing SW technology (2D IR mapping, etc.)	×
C-SWCTE 8	AI-based damage detection SW technology	×
C-SWCTE 9	AI-based damage recognition SW technology	×
C-SWCTE 10	Automatic damage calculation SW technology	×
C-SWCTE 11	Automatic MOS candidate recommendation SW technology	×
C-IFCTE 1	Communication firmware technology	•
C-IFCTE 2	CM-EO standard interface technology	•
C-IFCTE 3	CM-IR standard interface technology	•
C-IFCTE 4	CM-DL standard interface technology	•
C-IFCTE 5	CM-EO API technology	•
C-IFCTE 6	CM-IR API technology	•
C-IFCTE 7	CM-DL API technology	•
C-IFCTE 8	IR firmware technology	•
C-IFCTE 9	DL standard firmware technology	•
C-IFCTE 10	Standard data link construction technology	•
C-IFCTE 11	DL standard protocol technology	•
C-IFCTE 12	GC firmware technology	•
C-IFCTE 13	Web-based middleware technology	•
C-IFCTE 14	Web-based middleware technology	•
C-IFCTE 15	Web-based middleware technology	•

The core processes related to the key ROC quantitative objectives started from the moment the EO/IR sensors mounted on the UAVs captured the damage imagery.

It involved transmitting the captured images through a data link to and processing them at the control center.

The system automatically detected and classified types of damages after image processing.

Using the WBS, we identified the HW and SW configuration items relevant to these core processes.

The identified items and the corresponding mapped TEs represent TEs related to the key ROC quantitative objectives.

Additionally, by utilizing the interface matrix, we identified the interrelationships associated with the core processes.



TABLE 12. Final CTEs for ADARMS.

CTE ID	CTE name	CTE candidate ID
SWCTE 1	2D EO image processing SW technology (2D EO mapping, etc.)	C-SWCTE 6
SWCTE 2	2D IR image processing SW technology (2D IR mapping, etc.)	C-SWCTE 7
SWCTE 3	AI-based damage detection SW technology	C-SWCTE 8
SWCTE 4	AI-based damage recognition SW technology	C-SWCTE 9
SWCTE 5	Automatic damage calculation SW technology	C-SWCTE 10
SWCTE 6	Automatic MOS candidate recommendation SW technology	C-SWCTE 11

TABLE 13. Results of TRA for ADARMS.

CTE ID	CTE name		Results of TRA			
CIEID	CTE name	TRL	Reference			
SWCTE 1	2D EO image processing SW technology (2D EO mapping, etc.)	6	A-R&D project			
SWCTE 2	2D IR image processing SW technology (2D IR mapping, etc.)	6	A-R&D project			
SWCTE 3	AI-based damage detection SW technology	6	M-project, A-R&D project			
SWCTE 4	AI-based damage recognition SW technology	6	M-project, A-R&D project			
SWCTE 5	Automatic damage calculation SW technology	6	A-R&D project			
SWCTE 6	Automatic MOS candidate recommendation SW technology	6	A-R&D project			

TABLE 14. Technical WBS for NTDS.

Level 1	Level 2	Level 3	Level 4	Key ROC allocation
	Total data and a standard	DID	DLP HW	•
	Tactical data processing system	DLP equipment	DLP SW	•
		TDD	TDP HW	•
	Tactical operation system	TDP equipment	TDP SW	•
		DDDD .	RDBP HW	•
NTDS		RDBP equipment	RDBP SW	•
		TCC againment	TCC HW	×
		TCC equipment	TCC SW	×
	Tastical situational displacements	TCD a minus out	TSD HW	•
	Tactical situational display system	TSD equipment	TSD SW	•

DLP: Data link processing; TDP: Tactical data processing; RDBP: RDB processing; TCC: Tactical coordination console; TSD: Tactical situational display

Subsequently, we identified the IFTEs related to the key ROC quantitative objectives (Table 6).

b: DIFFICULTY EVALUATION

The results of evaluation of the technical difficulty for 16 HWTE and SWTE items unrelated to the key ROC objectives are summarized in Table 7.

SWTE15, SWTE16, and HWTE11 were evaluated with a difficulty level of 4 or higher as new technologies.

The remaining HWTEs and SWTEs can be sufficiently developed by modifying the technology acquired through projects such as H-UAV, M-UAV, A-C4I, or by leveraging existing technologies.

The technical difficulty evaluation was conducted for 25 IFTEs unrelated to the key ROC quantitative objectives, and the results are presented in Table 8.

All necessary TEs were already secured via the H-UAV, M-UAV, and A-C4I projects, so all technical difficulty levels of the IFTEs were evaluated as 2 or less.

c: SELECTION OF CTE CANDIDATES (FIRST)

Thirty-three CTE candidates (first) were selected by combining the ones related to the key ROC quantitative objectives and those with a technical-difficulty evaluation result of 4 or higher (Table 9).

Identifiers were allocated to the selected CTE candidates (first) and are presented in Table 10.

3) DETERMINATION OF COMMERCIAL OFF-THE-SHELF TECHNOLOGY APPLICATION

The assessment results for applying commercial off-the-shelf technology (COTS) to CTE candidates (first) are presented in Table 11.



TABLE 15. Definitions of NTDS HWTEs and SWTEs.

ר	ГВЅ	TE				
Level 2	Level 3	TE ID	TE ID Technology name Technology definition			
		HWTE 1	Embedded HW	Embedded HW design and development technology		
Tactical data processing	DLP equipment	SWTE 1	Real-time data link processing SW	Standard RT data link processing SW technology (link-11, 14, etc.)		
system	oquipment.	SWTE 2	External interface SW	Standard external interface SW technology (Sensor to NTDS, NTDS to external sys.)		
		HWTE 2	High-performance HW	High-performance CPU-based HW production technology		
	TDP	SWTE 3	Tactical track collection SW	Tactical track collection SW technology using standard data link protocol		
	equipment	SWTE 4	Tactical track data display SW	Tactical track data display SW technology		
Tactical		SWTE 5	Risk assessment support SW	Risk assessment support SW technology		
operation system		SWTE 6	Weapon control SW	Weapon control SW technology		
System	RDBP	HWTE 3	High-performance HW	High-performance CPU-based HW production technology		
	equipment	SWTE 7	DBMS SW	Real-time DBMS technology		
	TCC	HWTE 4	Embedded HW	Embedded HW design and development technology		
equipment		SWTE 8	Display firmware	Display firmware technology		
Tactical		HWTE 5	High-performance HW	High-performance CPU-based HW production technology		
situational display system	TSD equipment	SWTE 9	Tactical situation display SW	GIS-based tactical situation display SW technology		

TABLE 16. Identification Results of NTDS IFTEs.

TBS		DLP equipment		TDP equipment		RDBP equipment		TCC equipment		TSD equipment	
Level 3	Level 4	DLP HW	DLP SW	TDP HW	TDP SW	RDBP HW	RDBP SW	TCC HW	TCC SW	TSD HW	TSD SW
DLP	DLP HW		IFTE 1	IFTE 2							
equipment	DLP SW	IFTE 1			IFTE 3						
TDP	TDP HW	IFTE 2				IFTE 4		IFTE 5		IFTE 6	
equipment	TDP SW		IFTE 3	IFTE 7			IFTE 8		IFTE 9		IFTE 10
RDBP	RDBP HW			IFTE 4			IFTE 11				
equipment	RDBP SW				IFTE 8	IFTE 11					
TCC	TCC HW			IFTE 5					IFTE 12		
equipment	TCC SW				IFTE 9			IFTE 12			
TSD	TSD HW			IFTE 6							IFTE 13
equipment	TSD SW				IFTE 10					IFTE 13	

Feasibility of COTS technology application means that the TE can be implemented using COTS products or technology. The final decision regarding the application of COTS technology is determined by confirming evidence for its sale and operation within an actual system.

4) FINAL SELECTION OF CTES

Excluding the technologies obtainable through COTS from CTE candidates (first), six TEs were finally selected as CTEs for the ADARMS.



TABLE 17. Definitions of NTDS IFTEs.

Interface section		IFTE			
(TB	(TBS level 4)		Technology definition		
DLP HW	DLP SW	IFTE 1	Standard bus interface technology		
DLF HW	TDP HW	IFTE 2	Standard data link construction technology		
DLP SW	TDP SW	IFTE 3	Standard data link API		
	RDBP HW	IFTE 4	Optical communication technology		
TDP HW	TCC HW	IFTE 5	Optical communication technology		
	TSD HW	IFTE 6	Optical communication technology		
	TDP HW	IFTE 7	Middleware technology		
TDP SW	RDBP SW	IFTE 8	Middleware technology		
TDP SW	TCC SW	IFTE 9	TDP-TCC API technology		
	TSD SW	IFTE 10	TDP-TSD API technology		
RDBP SW	RDBP HW	IFTE 11	Real-time DBMS technology		
TCC HW	TCC SW	IFTE 12	TCC driver technology		
TSD HW	D HW TSD SW		GIS-based integration technology		

TABLE 18. Key ROC quantitative objective-related HWTEs/SWTEs.

TBS			TE	Key ROC-
Level 2	Level 3	TE ID	Technology definition	related items
		HWTE 1	Embedded HW design and development technology	•
Tactical data processing system	DLP equipment	SWTE 1	Standard RT data link processing SW technology (link-11, 14, etc.)	•
F		SWTE 2	Standard external interface SW technology (sensor to NTDS, NTDS to external sys.)	•
		HWTE 2	High-performance CPU-based HW production technology	•
	TDP equipment	SWTE 3	Tactical track collection SW technology using standard data link protocol	•
		SWTE 4	Tactical track data display SW technology	•
Tactical operation		SWTE 5	Risk assessment support SW technology	х
system		SWTE 6	Weapon control SW technology	×
	RDBP	HWTE 3	High-performance CPU-based HW production technology	•
	equipment	SWTE 7	Real-time DBMS technology	•
	TCC againment	HWTE 4	Embedded HW design and development technology	×
	TCC equipment	SWTE 8	Display firmware technology	х
Tactical situational	TCD againment	HWTE 5	High-performance CPU-based HW production technology	•
display system	TSD equipment	SWTE 9	GIS-based tactical situation display SW technology	•

The final CTEs selected by the evaluation team are outlined in Table 12.

D. TRA EXECUTION

Results of the TRA conducted for the final six CTEs are provided in Table 13.

Maturity was evaluated by verifying the evidence from the A-R&D and M-projects. Consequently, the system-level maturity of the ADARMS was rated as 6.

VII. NTDS

A. OVERVIEW OF NTDS

The NTDS operates sensors installed on navy ships and surveillance units to collect tactical target information in near real time and comprehensively share maritime tactical situations with related units.

This system supports rapid decision-making and command control of commanders by sharing the tactical situation of the Korean Peninsula in near real time.



TABLE 19. Key ROC quantitative objective-related IFTEs.

Interface section (TBS level 4)			IFTE	Von BOC voloted Home
		TE ID	Technology definition	Key ROC-related items
DLP HW	DLP SW IFTE 1 Standard bus interface technology		Standard bus interface technology	•
DEI IIW	TDP HW	IFTE 2	Standard data link construction technology	•
DLP SW	TDP SW	IFTE 3	Standard data link API	•
	RDBP HW	IFTE 4	Optical communication technology	•
TDP HW	TCC HW	IFTE 5	Optical communication technology	×
	TSD HW	IFTE 6	Optical communication technology	•
	TDP HW	IFTE 7	Middleware technology	•
TDP SW	RDBP SW	IFTE 8	Middleware technology	•
IDPSW	TCC SW	IFTE 9	TDP-TCC API technology	×
	TSD SW	IFTE 10	TDP-TSD API technology	•
RDBP SW	RDBP HW	IFTE 11	Real-time DBMS technology	•
TCC HW	TCC SW	IFTE 12	TCC driver technology	×
TSD HW	TSD SW	IFTE 13	GIS-based integration technology	•

TABLE 20. Difficulty evaluation results for HWTEs and SWTEs.

	WBS TE		Difficulty	Defenence musicat	
Level 2	Level 3	TE ID	E ID Technology Definition		Reference project
	TDD a main mant	SWTE 5	Risk assessment support SW technology	3	N-C4I project
Tactical TDP equipment	SWTE 6	Weapons control SW technology	3	N-C4I project	
operation system	TCC againment	HWTE 4	Embedded HW design and development technology	2	Ship combat system project
system	TCC equipment	SWTE 8	Display firmware technology	2	Ship combat system project

TABLE 21. Difficulty evaluation results for IFTEs.

Interface section (TBS level 4)			IFTE	Difficulty	Deference preject
		TE ID	TE ID Technology definition		Reference project
TDP HW	TCC HW	IFTE 5	Optical communication technology	2	N-C4I project
TDP SW	TCC SW	IFTE 9	TDP-TCC API technology	3	N-C4I project, ship combat sys. project
TCC HW	TCC SW	IFTE 12	TCC driver technology	2	N-C4I project, ship combat sys. project

The operational concept of the system is illustrated in Fig. 19.

When sensors (such as radars) installed on naval vessels, surveillance units, and similar assets detect maritime targets, the NTDS interface unit receives the target data, updates the tactical targets, and disseminates this information to higher-level units. Each fleet command consolidates the tactical target information from its subordinate units (such as naval vessels, surveillance units, etc.) to utilize it for tactical operations. The aggregated target information is then disseminated to the operational command headquarters. The operational command headquarters receives tactical information from

each fleet command and shares this information with joint command and control systems.

The primary ROC quantitative objective is the time (within 2 s; assumption) from the moment a radar system on a naval vessel or surveillance unit detects a target to the rapid transmission of target data via data links, displaying it on the tactical processor at the operational command headquarters.

B. DEVELOPMENT OF TECHNICAL WBS

The technical WBS of the NTDS are summarized in Table 14. The NTDS consists of a tactical data processing, operation,



TABLE 22. Selection of CTE candidates (first).

	TE	Key ROC-	Difficulty level
TE ID	Technology definition	related items	Difficulty level
HWTE 1	Embedded HW design and development technology	•	
HWTE 2	High-performance CPU-based HW production technology	•	
HWTE 3	High-performance CPU-based HW production technology	•	
HWTE 5	High-performance CPU-based HW production technology	•	
SWTE 1	Standard RT data link processing SW technology (link-11, 14, etc.)	•	
SWTE 2	Standard external interface SW technology (sensor to NTDS, NTDS to external sys.)	•	
SWTE 3	Tactical track collection SW technology using standard data link protocol	•	
SWTE 4	Tactical track data display SW technology	•	
SWTE 7	Real-time DBMS technology	•	
SWTE 9	GIS-based tactical situation display SW technology	•	
IFTE 1	Standard bus interface technology	•	
IFTE 2	Standard data link construction technology	•	
IFTE 3	Standard data link API	•	
IFTE 4	Optical communication technology	•	
IFTE 6	Optical communication technology	•	
IFTE 7	Middleware technology	•	
IFTE 8	Middleware technology	•	
IFTE 10	TDP-TSD API technology	•	
IFTE 11	Real-time DBMS technology	•	
IFTE 13	GIS-based integration technology	•	

TABLE 23. List of CTE candidates (first).

CTE candidate ID	CTE candidate (first)	TE ID
C-HWTE 2	High-performance CPU-based HW production technology	HWTE 2
C-HWTE 3	High-performance CPU-based HW production technology	HWTE 3
C-HWTE 4	High-performance CPU-based HW production technology	HWTE 5
C-SWTE 1	Standard RT data link processing SW technology (link-11, 14, etc.)	SWTE 1
C-SWTE 2	Standard external interface SW technology (sensor to NTDS, NTDS to external system)	SWTE 2
C-SWTE 3	Tactical track collection SW technology using standard data link protocol	SWTE 3
C-SWTE 4	Tactical track data display SW technology	SWTE 4
C-SWTE 5	Real-time DBMS technology	SWTE 7
C-SWTE 6	GIS-based tactical situation-display SW technology	SWTE 9
C-IFTE 1	Standard bus interface technology	IFTE 1
C-IFTE 2	Standard data link construction technology	IFTE 2
C-IFTE 3	Standard data link API	IFTE 3
C-IFTE 4	Optical communication technology	IFTE 4
C-IFTE 5	Optical communication technology	IFTE 6
C-IFTE 6	Middleware technology	IFTE 7
C-IFTE 7	Middleware technology	IFTE 8
C-IFTE 8	TDP-TSD API technology	IFTE 10
C-IFTE 9	Real-time DBMS technology	IFTE 11
C-IFTE 10	GIS-based integration technology	IFTE 13

and situation-display systems, which comprise five pieces of equipment.

C. SELECTION OF CTES

1) IDENTIFICATION OF TES

a: IDENTIFICATION OF HWTEs AND SWTEs

The HWTEs and SWTEs identified based on the technical WBS of the NTDS are summarized in Table 15.

We identified the necessary technology elements to develop the HW and SW configuration items corresponding to WBS Level 4. The HWTE consisted of one tactical data-processing system, three tactical operation systems, and two tactical situation-display systems that were identified. The SWTEs comprised two tactical data-processing systems, six tactical operation systems, and one tactical situation-display system that were identified.



TABLE 24. Determination of COTS technology application.

CTE candidate ID	CTE candidate (1st)	Application of COTS
C-HWTE 1	Embedded HW design & development technology	•
C-HWTE 2	High-performance CPU-based HW production technology	•
C-HWTE 3	High-performance CPU-based HW production technology	•
C-HWTE 4	High-performance CPU-based HW production technology	•
C-SWTE 1	Standard RT data link processing SW technology (link-11, 14, etc.)	×
C-SWTE 2	Standard external interface SW technology (sensor to NTDS, NTDS to external sys.)	×
C-SWTE 3	Tactical track collection SW technology using standard data link protocol	×
C-SWTE 4	Tactical track data display SW technology	×
C-SWTE 5	Real-time DBMS technology	•
C-SWTE 6	GIS-based tactical situation display SW technology	×
C-IFTE 1	Standard bus interface technology	•
C-IFTE 2	Standard data link construction technology	•
C-IFTE 3	Standard data link API	×
C-IFTE 4	Optical communication technology	•
C-IFTE 5	Optical communication technology	•
C-IFTE 6	Middleware technology	•
C-IFTE 7	Middleware technology	•
C-IFTE 8	TDP-TSD API technology	×
C-IFTE 9	Real-time DBMS technology	•
C-IFTE 10	GIS-based integration technology	×

TABLE 25. Final CTEs for NTDS.

CTE ID	CTE name	CTE candidate ID
SWCTE 1	Standard RT data link processing SW technology (link-11, 14, etc.)	C-SWTE 1
SWCTE 2	Standard external interface SW technology (sensor to NTDS, NTDS to external sys.)	C-SWTE 2
SWCTE 3	Tactical track collection SW technology using standard data link protocol	C-SWTE 3
SWCTE 4	Tactical track data display SW technology	C-SWTE 4
SWCTE 5	GIS-based tactical situation display SW technology	C-SWTE 6
IFCTE 1	Standard data link API	C-IFTE 3
IFCTE 2	TDP-TSD API technology	C-IFTE 8
IFCTE 3	GIS-based integration technology	C-IFTE 10

b: IDENTIFICATION OF IFTES

According to the NTDS operational concept, we identified 13 interfaces among the HW and SW configuration items (Table 16).

We investigated the data flow according to the operational concept of the NTDS and identified the interfacial relationships among the HW and SW configuration items of the system components. Table 17 summarizes the definitions of the identified IFTEs. It also defines the necessary

technologies for IFs among the HW and SW configuration items.

2) SELECTION OF CTE CANDIDATES (FIRST)

a: IDENTIFICATION OF TES RELATED TO KEY ROC QUANTITATIVE OBJECTIVES

The HWTEs and SWTEs related to the key ROC quantitative objectives were identified (Table 18).



TABLE 26. Results of TRA for NTDS.

CTE ID	CTE name	Results of TRA	
		TRL	Reference project
SWCTE 1	Standard RT data link processing SW technology (link-11, 14, etc.)	7	N-C4I project, MCRC project
SWCTE 2	Standard external interface SW technology (sensor to NTDS, NTDS to external sys.)	7	N-C4I project, ship combat sys. project
SWCTE 3	Tactical track collection SW technology using standard data link protocol	6	N-C4I project, MCRC project
SWCTE 4	Tactical track data display SW technology	7	N-C4I project, ship combat sys. project
SWCTE 5	GIS-based tactical situation display SW technology	7	N-C4I project, ship combat sys. project
IFCTE 1	Standard data link API	7	N-C4I project, MCRC project
IFCTE 2	TDP-TSD API technology	7	N-C4I project, ship combat sys. Project
IFCTE 3	GIS-based integration technology	8	N-C4I project, J-C4I project

The core processes related to the key ROC quantitative objectives were as follows: when sensors operational onboard naval vessels and surveillance units detected a target, the DLP collected and processed the target information through IFs connected to the sensors and subsequently transmitted it to the TDP. The TDP utilized information from the RDBP to fuse data, which were then transmitted to the TSD for display on the situational map.

Based on the NTDS WBS, we identified the HW and SW configuration items involved in handling these core processes. Furthermore, we defined the TEs required for developing each configuration item and mapped it in relation to the key ROC quantitative objectives.

Furthermore, by utilizing the system's operational concept and the IF matrix, we tracked processes related to the key ROC quantitative objectives and identified the associated IFTEs. The identified IFTEs related to key ROC quantitative objectives are listed in Table 19. The IFs with sensors, such as radar, to collect data at the DLP, transmitting them to the TDP via data links, and finally integrating them with the RDBP information for display on the TSD, fall under this category.

b: DIFFICULTY EVALUATION

We conducted a technology-difficulty evaluation for four TEs unrelated to the key ROC objectives (Table 20). The identified HWTEs and SWTEs consisted of TEs secured via the N-C4I project and naval combat system project, which was evaluated at a difficulty level of 3 or lower.

Furthermore, the technological difficulty evaluation results for three IFTE unrelated to key ROC quantitative objectives are presented in Table 21. The identified IFTEs, secured through the N-C4I project and naval combat system project, were evaluated at a difficulty level of 3 or lower, utilizing technology that had already been secured.

c: SELECTION OF CTE CANDIDATES (FIRST)

We selected the CTE candidates (first) by combining the TEs related to the key ROC quantitative objectives and those rated with a technological difficulty of 4 or higher. The results are listed in Table 22.

Regarding the NTDS project, there were no TEs rated with a difficulty of 4 or higher in the technological difficulty evaluation. Therefore, identifiers were allocated to the selected CTE candidates (first) and organized as outlined in Table 23.

3) DETERMINATION OF COTS TECHNOLOGY APPLICATION

The assessment results for applying COTS technology to the CTE candidates (first) are displayed in Table 24. The feasibility of COTS technology application means that the TE can be implemented using COTS or technology. The final decision regarding the application of COTS technology was determined by confirming the evidence for its sale and operation within an actual system.

4) FINAL SELECTION OF CTES

Excluding the technologies obtainable through COTS from the CTE candidates (first), eight TEs were finally selected as CTEs for the NTDS. The final CTEs selected by the evaluation team are outlined in Table 25.

D. TRA EXECUTION

The results of the TRA conducted for the final eight CTEs are presented in Table 26. The maturity was evaluated through evidence verification from the N-C4I project, MCRC project, and naval combat system projects. The system level maturity of the NTDS was rated as 6.

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